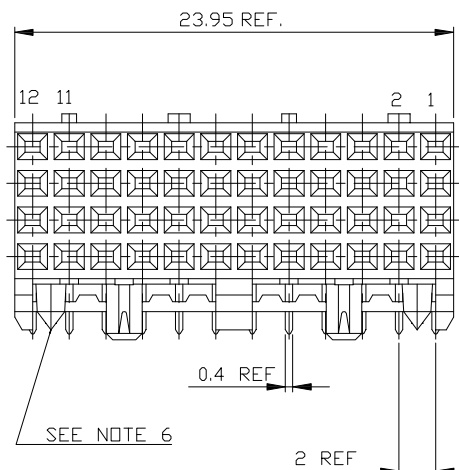
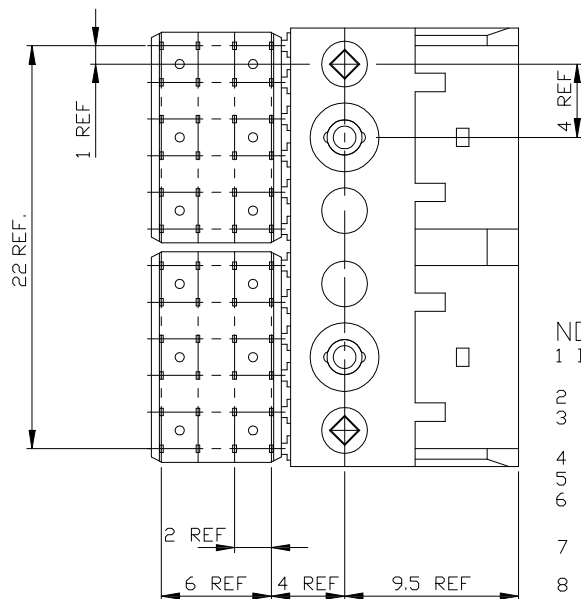
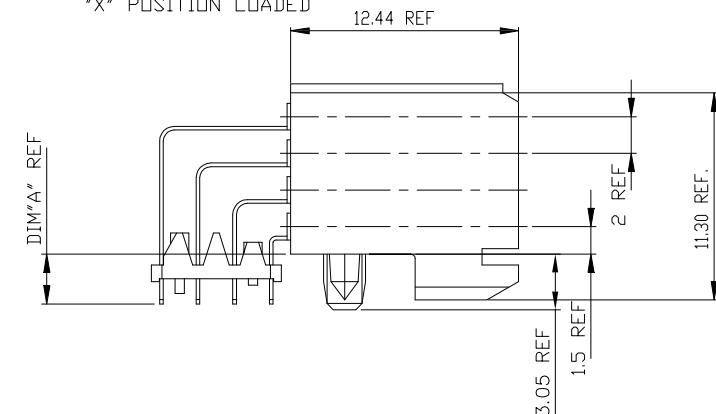


1						2						3		4	
PRODUCT NR:		CONFIGURATION												DIM A	PCB THICKNESS
	ROW#	1	2	3	4	5	6	7	8	9	10	11	12		
85868-X01	D	-	X	X	X	-	X	-	X	-	X	-	X	2.90	1.6
	C	X	-	X	-	X	-	X	-	X	-	X	-		
85868-X01LF	B	-	X	X	X	-	X	-	X	-	X	-	X	2.90	1.6
	A	X	-	X	-	X	-	X	-	X	-	X	-		
85868-X02	D	X	-	X	-	X	-	X	-	X	-	X	-	2.90	1.6
	C	-	X	-	X	-	X	-	X	-	X	-	X		
85868-X02LF	B	X	-	X	-	X	-	X	-	X	-	X	-	2.90	1.6
	A	-	X	-	X	-	X	-	X	-	X	-	X		
85868-X03	D	X	X	X	X	X	X	-	X	X	X	-	X	2.90	1.6
	C	X	X	X	X	X	X	-	X	X	X	-	X		
85868-X03LF	B	X	X	X	X	X	X	-	X	X	X	-	X	2.90	1.6
	A	X	X	X	X	X	X	-	X	X	X	-	X		

"-" POSITION NOT LOADED
 "X" POSITION LOADED



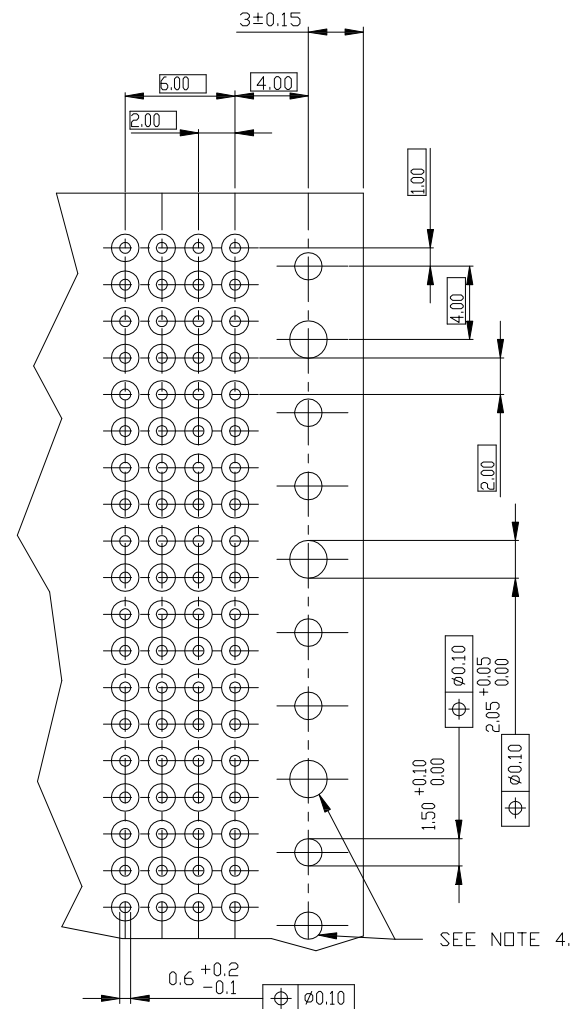
PRODUCT AFTER PC BOARD APPLICATION.

PC BOARD THICKNESS ±0.20
 SEE TABLE

NOTES:

- BODY MAT'L: LIQUID CRYSTAL POLYMER 30% GLASS
FLAME RETARDANT ACC. UL 94-V0
- TERMINAL MATERIAL: PHOSPHOR BRONZE.
- PLATING SOLDER TAILS 2-8 μm SnPb 90-10, OR 2-8 μm PURE Sn FOR PART NUMBER WITH LF SUFFIX.
- INDICATED HOLES ARE UNPLATED.
- PRODUCT MARKING: PART NUMBER & BATCH ID.
- DIAMOND LOCATION PEG ARE ONLY EXISTED ON THE BOTH SIDES OF PRODUCT.
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260 DEGREE PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION.

PLATING CONTACT AREA:	
DASH NR:	PERFORMANCE LEVEL
-1YY/1YYLF	TELCORDIA CO
-2YY/2YYLF	CUSTOMER SPECIAL
-3YY/3YYLF	CUSTOMER SPECIAL

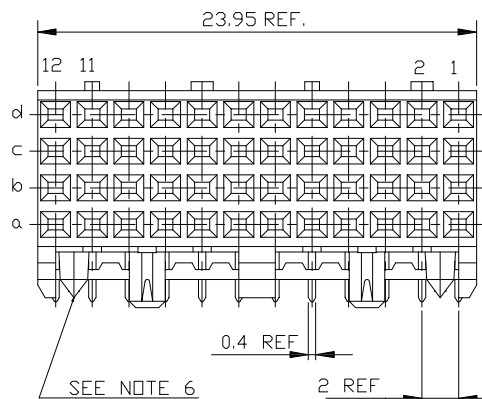
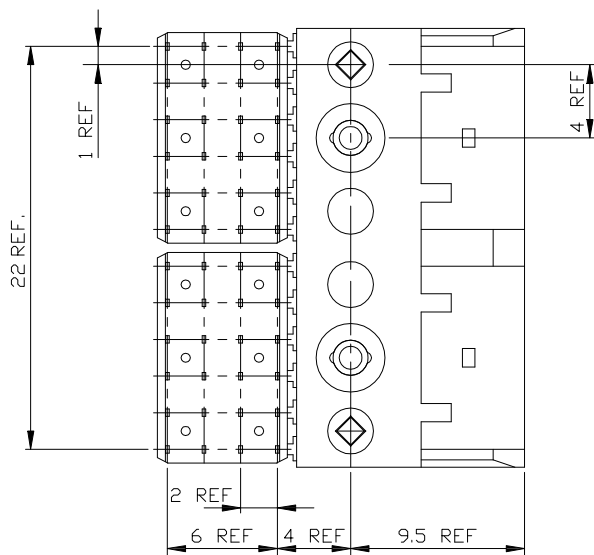
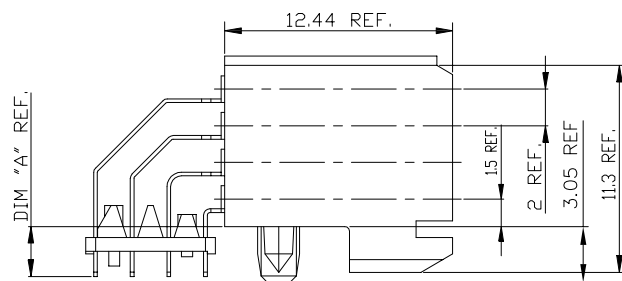


RECOMMENDED HOLE PATTERN,
 COMPONENT SIDE.

mat'l code		tolerances unless otherwise specified		CUSTOMER COPY		FCI	
l	tr	ec	n	dr	date	linear	projection
H	T03-0430	Jeff	030926				
J	D604-0012	Clu	040225				
K	D605-0061	Clu	050328				
L	D606-0478	Cen	11/23/06	dir	D. de Bil	980109	
M	D607-0169	Cen	05/15/07	eng	P. Schalk	980109	
N	D608-0171	TER	8/26/08	chr	P. Schalk	980109	
P	D609-0068	Cen	06/06/09	app	P. Schalk	980109	
sheet	revision	P	P				
index	sheet	1	2	3			

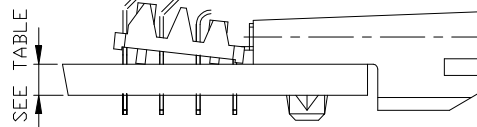
1					2								3		4			
PRODUCT NR:		CONFIGURATION												DIM A	PCB THICKNESS			
	ROW#	1	2	3	4	5	6	7	8	9	10	11	12					
85868-X30 85868-X30LF	D	X	-	X	-	X	-	X	-	X	-	X	-	2.90	1.6			
	C	X	-	-	X	-	X	-	X	-	X	-	X					
	B	X	-	X	-	X	-	X	-	X	-	X	-			X		
	A	X	-	-	X	-	X	-	X	-	X	-	X			-	X	
85868-X31 85868-X31LF	D	X	-	X	-	X	-	X	-	X	-	X	-	2.90	1.6			
	C	-	X	-	X	-	X	-	X	-	X	-	X			-	X	
	B	X	-	X	-	X	-	X	-	X	-	X	-			X	-	X
	A	-	X	-	X	-	X	-	X	-	X	-	X			-	X	-
85868-X32 85868-X32LF	D	X	X	X	X	X	X	-	X	X	X	-	X	2.90	1.6			
	C	X	X	X	X	X	X	-	X	X	X	-	X			-	X	
	B	X	X	X	X	X	X	-	X	X	X	-	X			-	X	
	A	X	X	X	X	X	X	-	X	X	X	-	X			-	X	
85868-X33 85868-X33LF	D	-	X	X	X	-	X	-	X	-	X	-	X	2.90	1.6			
	C	X	-	X	-	X	-	X	-	X	-	X	-			X	-	X
	B	-	X	X	X	-	X	-	X	-	X	-	X			-	X	
	A	X	-	X	-	X	-	X	-	X	-	X	-			X	-	X

"-" POSITION NOT LOADED
 "X" POSITION LOADED



PRODUCT AFTER PC BOARD APPLICATION.

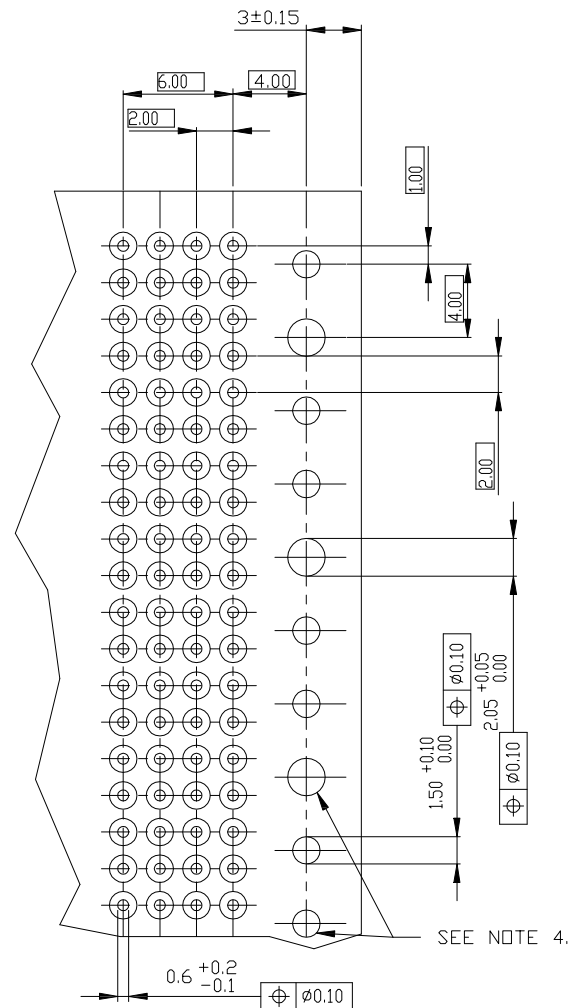
PC BOARD THICKNESS ±0.20



NOTES:

- 1 BODY MAT'L: LIQUID CRYSTAL POLYMER 30% GLASS
FLAME RETARDANT ACC. UL 94-V0
- 2 TERMINAL MATERIAL: PHOSPHOR BRONZE.
- 3 PLATING SOLDER TAILS 2-8 μ m SnPb 90-97.
OR 2-8 μ m PURE Sn FOR PART NUMBER WITH LF SUFFIX.
- 4 INDICATED HOLES ARE UNPLATED.
- 5 PRODUCT MARKING: PART NUMBER & BATCH ID.
- 6 DIAMOND LOCATION PEG ARE ONLY EXISTED ON THE BOTH SIDES OF PRODUCT.
- 7 THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- 8 THE HOUSING WILL WITHSTAND EXPOSURE TO 260 DEGREE PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION.

PLATING CONTACT AREA:	
DASH NR:	PERFORMANCE LEVEL
-1YY/1YYLF	TELCORDIA CO
-2YY/2YYLF	CUSTOMER SPECIAL
-3YY/3YYLF	CUSTOMER SPECIAL



RECOMMENDED HOLE PATTERN, COMPONENT SIDE.

mat'l. code		tolerances unless otherwise specified		CUSTOMER COPY		FCI	
l	tr	ec	n	dr	date	linear	projection
P						angles	mm
dr	Heaven Cen	11/23/06					
engr	Collins Lu	11/23/06					
chr	Beer Fu	11/23/06					
app	Joseph Hsia	11/23/06					
sheet	revision					scale	5:1
index	sheet						
title		product family		code		size	
4R RA RECEPTACLE		METAL (tm)		213		3 of 3	
SIG24mm PRESS PEG		A2		85868			